

January 2010

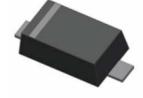
# BAT42XV2-BAT43XV2 Schottky Barrier Diodes

## **Features**

- Low Forward Voltage Drop
- Flat Lead, Surface Mount Device at 0.60mm Height
- Extremely Small Outline Plastic Package SOD523F
- · Moisture Level Sensitivity 1
- · Pb-free Version and RoHS Compliant
- · Matte Tin (Sn) Lead Finish
- Green Mold Compound



**ELECTRICAL SYMBOL** 



BAT42XV2 Marking : 6B BAT43XV2 Marking : 7B

SOD-523F Band Indicates Cathode

# **Absolute Maximum Ratings \*** $T_A$ =25°C unless otherwise noted

Symbol	Parameter	Value	Units	
$V_{RRM}$	Maximum Repetitive Reverse Voltage	30	V	
V <sub>R</sub>	Maximum DC Blocking Voltage	30	V	
I <sub>F(AV)</sub>	Average Rectified Forward Current	200	mA	
I <sub>FSM</sub>	Peak Forward Surge Current	4	Α	
TJ	Operating Junction Temperature	+125	°C	
T <sub>STG</sub>	Storage Temperature Range	-65 to +125	°C	

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

# Thermal Characteristics T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units	
P <sub>D</sub>	Power Dissipation	200	mW	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	500	°C/W	

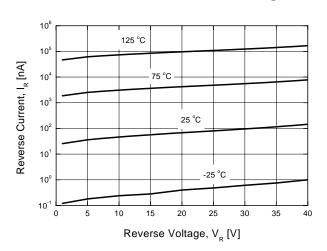
<sup>\*</sup> Device mounted on FR-4 PCB minimum land pad.

# **Electrical Characteristics** $T_A=25$ °C unless otherwise noted

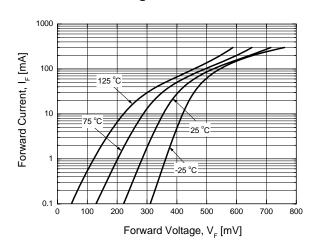
Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>R</sub>	Breakdown Voltage	I <sub>R</sub> =100μA	30			V
I <sub>R</sub>	Reverse Leakage Current	V <sub>R</sub> =25V			500	nA
V <sub>F</sub>	Forward Voltage BAT42XV2	I <sub>F</sub> =10mA I <sub>F</sub> =50mA			0.40 0.65	
		I <sub>F</sub> =2mA I <sub>F</sub> =15mA	0.26		0.33 0.45	V
	BAT42XV2, BAT43XV2	I <sub>F</sub> =200mA			1.0	
T <sub>RR</sub>	Reverse Recovery Time	$I_F = I_R = 10 \text{mA}$ $R_L = 100 \Omega$ $I_{RR} = 1 \text{mA}$		5		nS
С	Capacitance	V <sub>R</sub> =1V, f=1MHz		7		pF

# **Typical Performance Characteristics**

## **Reverse Current vs Reverse Voltage**

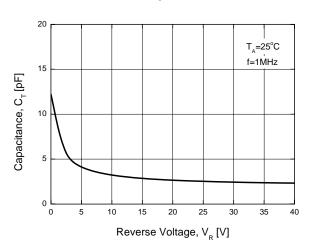


## **Forward Voltage vs Forward Current**

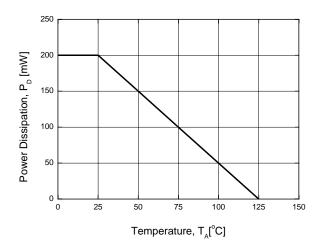


# Typical Performance Characteristics (Continued)

# **Total Capacitance**

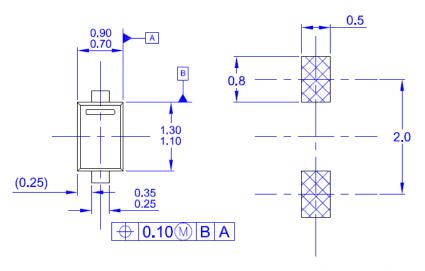


# **Power Derating Curve**

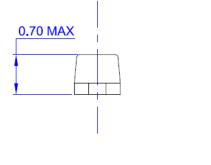


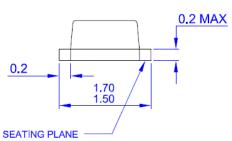
# **Physical Dimension**

## **SOD-523F**



LAND PATTERN RECOMMENDATION





## NOTES: UNLESS OTHERWISE SPECIFIED

- A) PACKAGE REFERENCE: THIS PACKAGE OUTLINE CONFORMS TO JEITA SC-79.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.

- C) DRAWING CONFORMS TO ASME Y14,5M 1994
  D) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
  E) LANDPATTERN RECOMMENDATION IS BASED ON IPC7351A STANDARD SOD1609X65M,
- F) DRAWING NUMBER AND REVISION:MKT-SOD523F1rev1





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Definition of Terms				
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